# imall

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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# APTDF400KK100G

# Dual Common Cathode diodes Power Module

A1

A2



#### Application

- Uninterruptible Power Supply (UPS)
- Induction heating
- Welding equipment
- High speed rectifiers

#### Features

- Ultra fast recovery times
- Soft recovery characteristics
- High blocking voltage
- High current
- Low leakage current
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration

#### Benefits

- Outstanding performance at high frequency operation
- Low losses
- Low noise switching
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- RoHS Compliant

### Absolute maximum ratings

Δ.

_	Symbol	Parameter			Max ratings	Unit	
I	$V_R$	Maximum DC reverse Voltage			1000	V	
	V <sub>RRM</sub>	M Maximum Peak Repetitive Reverse Voltage				1000	v
ſ	т	Maximum Average Forward	Derte avala	Duty cycle = 50% $\frac{T_C = 25^{\circ}C}{T_C = 70^{\circ}C}$		500	
	$\mathbf{I}_{\mathrm{F}(\mathrm{AV})}$	Current	Duty cycle =			400	Δ
	I <sub>F(RMS)</sub>	RMS Forward Current	Duty cycle =	= 50%	$T_C = 45^{\circ}C$	500	Π
	I <sub>FSM</sub>	Non-Repetitive Forward Surge Cu	irrent 8	.3ms	$T_C = 45^{\circ}C$	3000	

A2

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

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## All ratings (a) $T_j = 25^{\circ}C$ unless otherwise specified

### **Electrical Characteristics**

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
	Diode Forward Voltage	$I_F = 400A$			2.1	2.7	
$V_{\rm F}$		$I_F = 600A$			2.3		V
		$I_{\rm F} = 400 {\rm A}$	$T_j = 125^{\circ}C$		1.7		
т	Maximum Reverse Leakage Current	$V_{\rm p} = 1000 V$	$T_i = 25^{\circ}C$			250	۸
I <sub>RM</sub>			$T_{j} = 125^{\circ}C$			1000	μA
CT	Junction Capacitance	$V_{R} = 1000V$			480		pF

## **Dynamic Characteristics**

Symbol	Characteristic	Test Conditions		Min	Тур	Max	Unit
t <sub>rr</sub>	Reverse Recovery Time	$I_{F}=1A, V_{R}=30V$ di/dt = 400A/ $\mu$ s	$T_j = 25^{\circ}C$		45		ns
t <sub>rr</sub>	Reverse Recovery Time		$T_j = 25^{\circ}C$		290		ns
۲r	Reverse Recovery Time		$T_{j} = 125^{\circ}C$		340		115
Q <sub>rr</sub>	Reverse Recovery Charge	$I_{\rm F} = 400 {\rm A}$ $V_{\rm R} = 667 {\rm V}$	$T_j = 25^{\circ}C$		2.7		μC
Qπ	Reverse Recovery Charge	$di/dt = 800A/\mu s$	$T_{j} = 125^{\circ}C$		14.6		μΟ
I	Reverse Recovery Current		$T_j = 25^{\circ}C$		24		А
I <sub>RRM</sub>	Reverse Recovery Current		$T_j = 125^{\circ}C$		72		
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 400A$ $V_R = 667V$ $di/dt = 4000A/\mu s$			160		ns
Q <sub>rr</sub>	Reverse Recovery Charge		$T_j = 125^{\circ}C$		28.4		μC
I <sub>RRM</sub>	Reverse Recovery Current				280		А

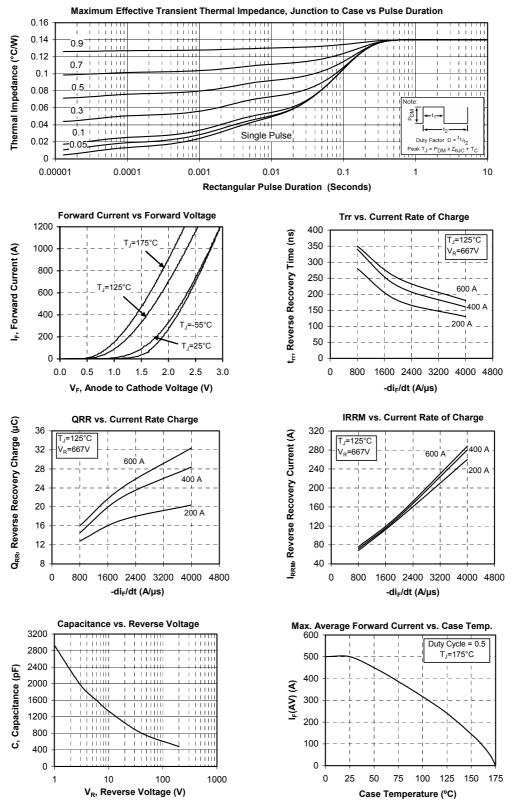
### Thermal and package characteristics

Symbol	Characteristic			Min	Тур	Max	Unit
R <sub>thJC</sub>	Junction to Case					0.14	°C/W
VISOL	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V
T <sub>J</sub>	Operating junction temperature range			-40		175	°C
T <sub>STG</sub>	Storage Temperature Range Operating Case Temperature			-40		125	
T <sub>C</sub>				-40		100	
Torque	Mounting torque	To heatsink	M6	3		5	N.m
Torque		For terminals	M5	2		3.5	19.111
Wt	Package Weight					300	g



# APTDF400KK100G

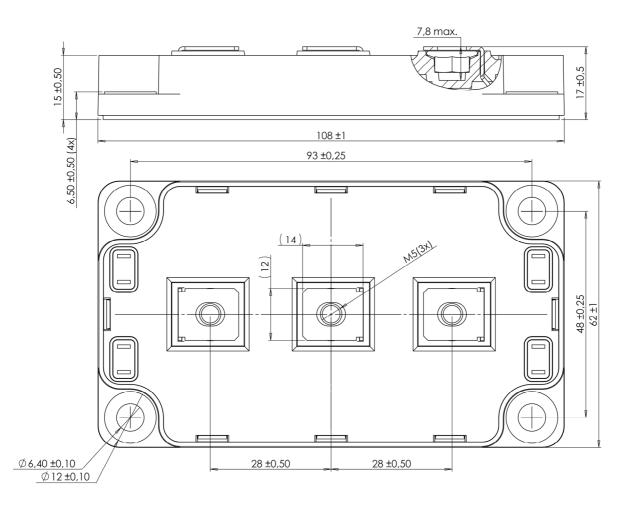
#### **Typical Performance Curve**



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### SP6 Package outline (dimensions in mm)





# APTDF400KK100G

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